

INTERNATIONAL STANDARD

NORME INTERNATIONALE



BASIC SAFETY PUBLICATION

PUBLICATION FONDAMENTALE DE SÉCURITÉ

**Insulation coordination for equipment within low-voltage systems –
Part 3: Use of coating, potting or moulding for protection against pollution**

**Coordination de l'isolement des matériels dans les systèmes (réseaux) à basse
tension –
Partie 3: Utilisation de revêtement, d'empotage ou de moulage pour la protection
contre la pollution**



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**INSULATION COORDINATION FOR EQUIPMENT
WITHIN LOW-VOLTAGE SYSTEMS –****Part 3: Use of coating, potting or moulding
for protection against pollution**

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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This consolidated version of IEC 60664-3 consists of the second edition (2003) [documents 109/24/FDIS and 109/31/RVD], its amendment 1 (2010) [documents 109/79/FDIS and 109/81/RVD] and its corrigendum of November 2010. It bears the edition number 2.1.

The technical content is therefore identical to the base edition and its amendment and has been prepared for user convenience. A vertical line in the margin shows where the base publication has been modified by amendment 1. Additions and deletions are displayed in red, with deletions being struck through.

International Standard IEC 60664-3 has been prepared by IEC technical committee 109: Insulation coordination for low-voltage equipment.

It has the status of a basic safety publication in accordance with IEC Guide 104.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The major changes made during the revision of IEC 60664-3 were the following:

- Part 3 has been exactly aligned with Part 1 (including amendments 1 and 2). It has been made clear that Part 3 can only be used as a whole document together with Part 1 of IEC 60664.
- The scope of Part 3 has been greatly extended including now also potting and moulding and similar procedures providing protection against pollution. The standard also applies to all kinds of coated printed boards including the surface of inner-layers of multi-layer boards, substrates and similar protected assemblies. The distances through an inner layer of multi-layer boards however are covered by the requirements for solid insulation in Part 1.
- The difference between the two types of protection has been clarified. Type 1 (formerly type A) protection leads to a reduction of the pollution degree present beyond the protection to pollution degree 1. Type 2 (formerly type B) protection introduces protection systems which can be considered similar to solid insulation. Consequently the dimensioning and test requirements have been aligned more correctly.
- The area of application has been extended including now functional, basic, supplementary and reinforced insulation.
- Type 1 and type 2 protection now can both be used under the conditions of pollution degree 3 (formerly only type B).
- Not only type 2 protection but also type 1 protection requires that between two conductive parts 100 % of the distance across the spacing shall be covered by the protection.
- For type 2 protection minimum distances have been introduced. In any case the spacings shall not be lower than the minimum value of 10 µm.
- Also the new Part 5 of IEC 60664 is referred to.
- The tests follow much more closely the different requirements for type 1 and type 2 protection. The protected assembly shall withstand the electrical tests for solid insulation in 4.1.2 of IEC 60664-1. For type 1 protection, the partial discharge test is not applicable. For type 2 protection, the partial discharge test is required. The required partial discharge extinction voltage and the test method are specified in 4.1.2.4 of IEC 60664-1.
- The requirements for the test specimen have been aligned with the extended scope.
- The tests for the “adhesion of coating” and the “scratch resistance test” have been updated.

IEC 60664 consists of the following parts under the general title *Insulation coordination for equipment within low-voltage systems*:

Part 1: Principles, requirements and tests

Part 2: Application guide

Part 3: Use of coating, potting or moulding for protection against pollution

Part 4: Consideration of high-frequency voltage stress

Part 5: A comprehensive method for determining clearances and creepage distances equal to or less than 2 mm

The committee has decided that the contents of the base publication and its amendments will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The “colour inside” logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this publication using a colour printer.

Withdrawn

INTRODUCTION

This part of IEC 60664 details the conditions in which the reduction of clearance and creepage distances can apply to rigid assemblies such as printed boards or terminals of components. Protection against pollution can be achieved by any kind of encapsulation such as coating, potting or moulding. The protection may be applied to one or both sides of the assembly. This standard specifies the insulating properties of the protecting material.

Between any two unprotected conductive parts, the clearance and creepage distance requirements of IEC 60664-1 or IEC 60664-5 apply.

This standard refers only to permanent protection. It does not cover assemblies after repair.

Technical committees need to consider the influence on the protection of overheated conductors and components, especially under fault conditions, and to decide if any additional requirements are necessary.

Safe performance of assemblies is dependent upon a precise and controlled manufacturing process for the application of the protective system. Requirements for quality control, e.g. by sampling tests, should be considered by technical committees.

Withdrawn

INSULATION COORDINATION FOR EQUIPMENT WITHIN LOW-VOLTAGE SYSTEMS –

Part 3: Use of coating, potting or moulding for protection against pollution

1 Scope

This part of IEC 60664 applies to assemblies protected against pollution by the use of coating, potting or moulding, thus allowing a reduction of clearance and creepage distances as described in Part 1 or Part 5.

NOTE 1 When reference is made to Part 1 or Part 5, IEC 60664-1 or IEC 60664-5 are meant.

This standard describes the requirements and test procedures for two methods of protection:

- type 1 protection improves the microenvironment of the parts under the protection;
- type 2 protection is considered to be similar to solid insulation.

This standard also applies to all kinds of protected printed boards, including the surface of inner layers of multi-layer boards, substrates and similarly protected assemblies. In the case of multi-layer printed boards, the distances through an inner layer are covered by the requirements for solid insulation in Part 1.

NOTE 2 Examples of substrates are hybrid integrated circuits and thick-film technology.

This standard refers only to permanent protection. It does not cover assemblies that are subjected to mechanical adjustment or repair.

The principles of this standard are applicable to functional, basic, supplementary and reinforced insulation.

2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

~~IEC 60068-2-1:1990, Environmental testing – Part 2: Tests – Tests A: Cold
Amendment 1 (1993)
Amendment 2 (1994)~~

~~IEC 60068-2-2:1974, Basic environmental testing procedures – Part 2: Tests – Tests B:
Dry heat
Amendment 1 (1993)
Amendment 2 (1994)~~

~~IEC 60068-2-14:1984, Basic environmental testing procedures – Part 2: Tests – Test N:
Change of temperature
Amendment 1 (1986)~~

~~IEC 60068-2-78:2001, Environmental testing – Part 2-78: Tests – Test Cab: Damp heat,
steady state~~